



# DB2X41100L

## Silicon epitaxial planar type

For rectification  
 DB2J411 in Mini2 type package

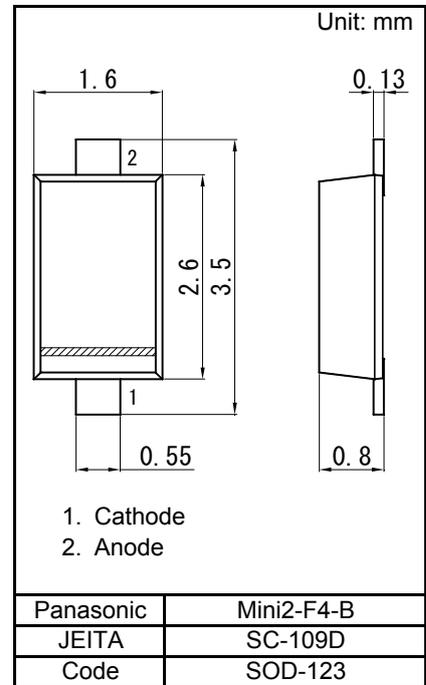
### ■ Features

- Low forward voltage and low reverse leakage current
- Short reverse recovery time  $t_{rr}$
- Halogen-free / RoHS compliant  
 (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

### ■ Marking Symbol: 4R

### ■ Packaging

Embossed type (Thermo-compression sealing) : 3 000 pcs / reel (standard)

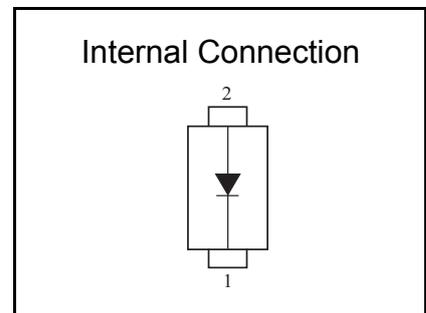


### ■ Absolute Maximum Ratings $T_a = 25\text{ }^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Reverse voltage	VR	40	V
Forward current (average) <sup>*1</sup>	IF(AV)	1	A
Non-repetitive peak forward surge current <sup>*2</sup>	IFSM	7	A
Junction temperature <sup>*1</sup>	Tj	150	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +150	°C

Note: <sup>\*1</sup>  $T_I = 80\text{ }^\circ\text{C}$

<sup>\*2</sup> 50 Hz sine wave 1 cycle (Non-repetitive peak current)



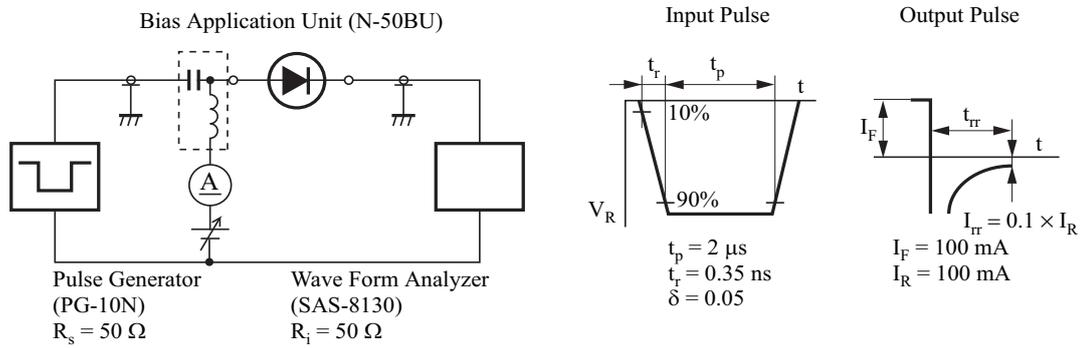


■ Electrical Characteristics  $T_a = 25\text{ }^\circ\text{C} \pm 3\text{ }^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Forward voltage	VF	IF = 1 A		0.50	0.58	V
Reverse current	IR	VR = 40 V		15	100	$\mu\text{A}$
Terminal capacitance	Ct	VR = 10 V, f = 1 MHz		21		pF
Reverse recovery time *1	trr	IF = IR = 100 mA, Irr = 0.1 × IR		6.8		ns

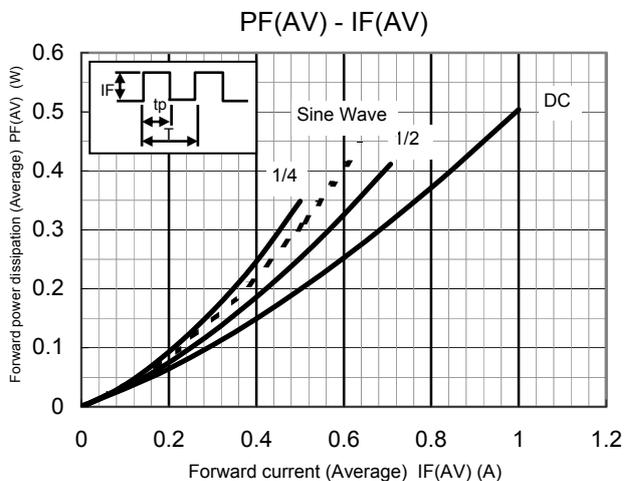
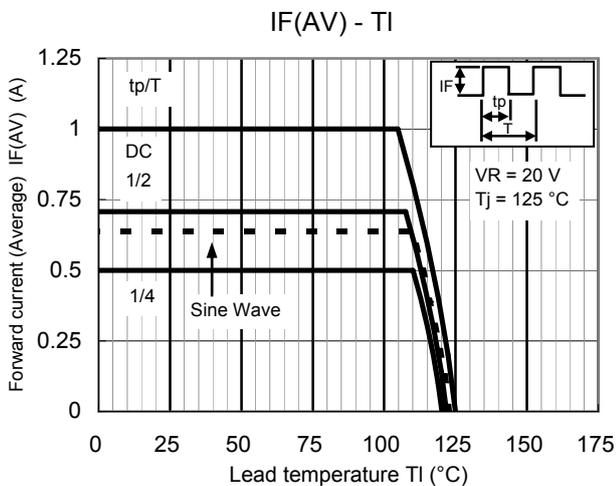
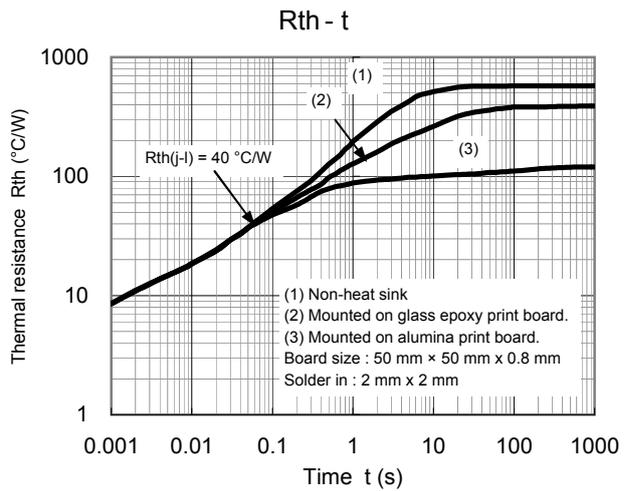
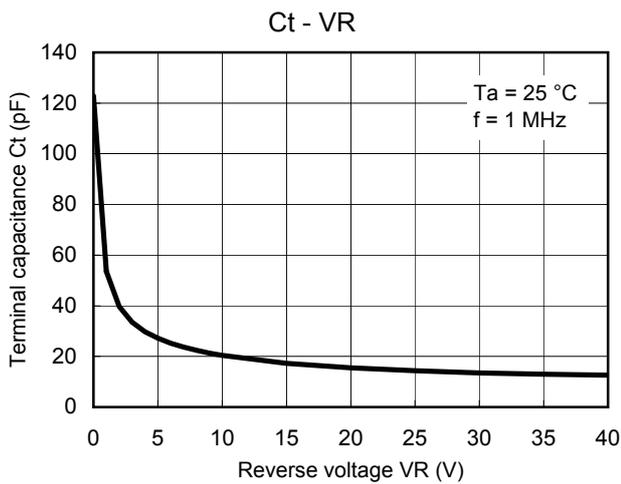
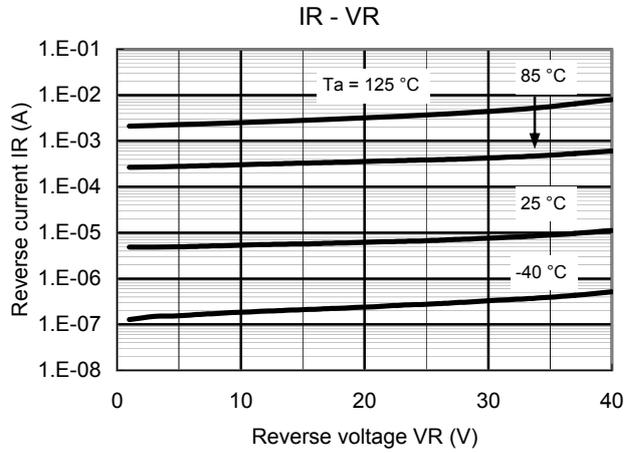
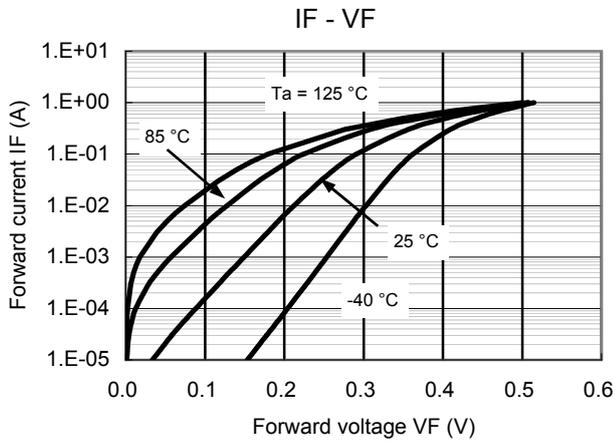
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

- This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
- \*1 trr test circuit





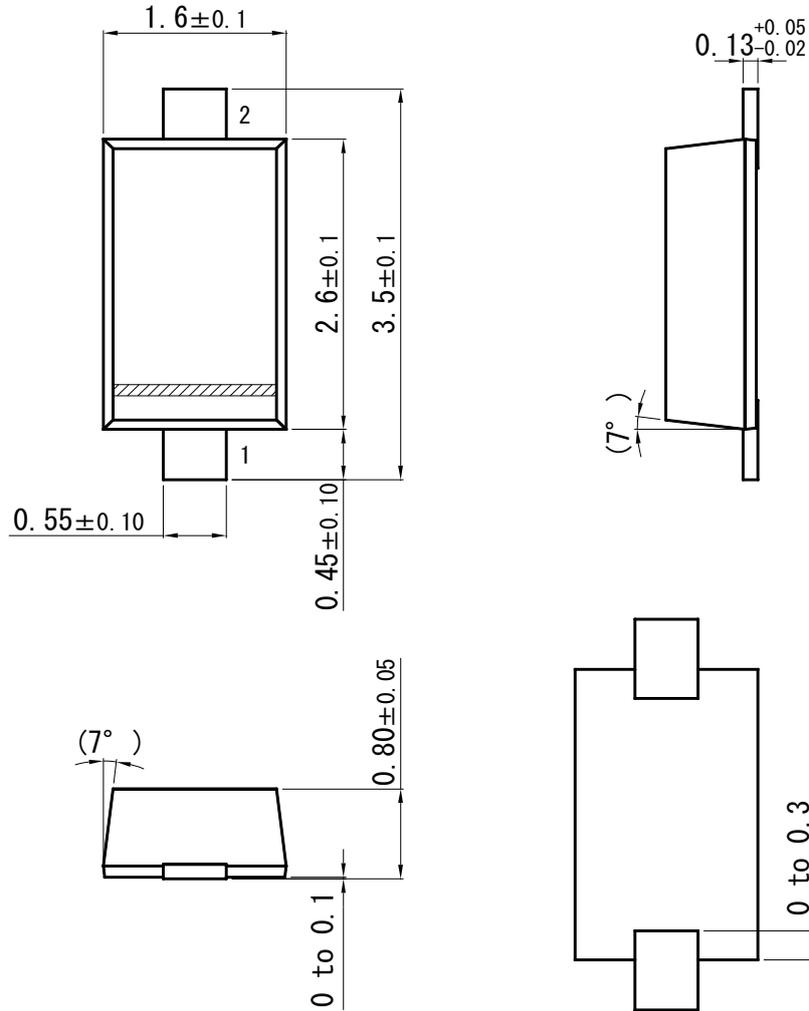
Technical Data ( reference )



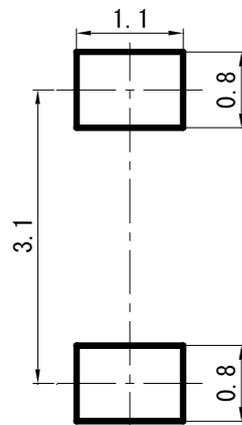


### Mini2-F4-B

Unit: mm



#### ■ Land Pattern (Reference) (Unit: mm)



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